

STPS200170TV1Y

Automotive high voltage power Schottky rectifier

Features

- Negligible switching losses
- Avalanche rated
- Low leakage current
- Good trade-off between leakage current and forward voltage drop
- Insulated package:
 - Electrical insulation = 2500 V rms,
 - Capacitance = 45 pF
- AEC-Q101 qualified

Description

This high voltage Schottky rectifier is suitable for high frequency switch mode power supplies.

Packaged in ISOTOP, this device is intended for use in secondary rectification applications.

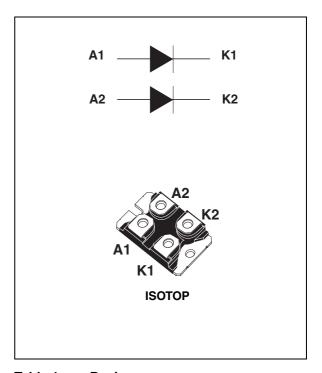


Table 1. Device summary

I _{F(AV)}	2 x 100 A
V _{RRM}	170 V
Tj	150 °C
V _F (typ)	0.63 V

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Characteristics 1

Table 2. Absolute ratings - limiting values per diode at T_{amb} = 25 °C, unless otherwise specified

Symbol	Parameter				Unit
V_{RRM}	Repetitive peak reverse voltage			170	V
I _{F(RMS)}	Forward rms current			200	Α
I _{F(AV)}	Average forward current, δ = 0.5 T_c = 105 °C per diode		100	Α	
I _{FSM}	Surge non repetitive forward current	t _p = 10 ms sinusoidal		700	Α
P _{ARM}	Repetitive peak avalanche power	t_p = 1 μ s, T_j = 25 $^{\circ}$	100000	W	
T _{stg}	Storage temperature range			-55 to + 150	°C
Tj	Maximum operating junction temperature ⁽¹⁾			150	°C

 $[\]frac{\frac{dP_{tot}}{dT_{j}} < \frac{1}{R_{th(j-a)}}}{Theri$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal parameters

Symbol	Parameter		Value	Unit
D	Junction to case	Per diode	0.52	
$R_{th(j-c)}$	Total	0.31	°C/W	
R _{th(c)}	Coupling thermal resistance		0.1	

When the diodes are used simultaneously:

 $T_{j(diode1)} = P_{(diode1)} X R_{th(j-c)} (per diode) + P_{(diode2)} X R_{th(c)}$

Table 4. Static electrical characteristics

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	Reverse leakage current	T _j = 25 °C	V- - V	·	-	200	μΑ
'R	Theverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$	-	30	100	mA
		T _j = 25 °C	I _F = 100 A	-	-	0.85	
V _E ⁽²⁾	Forward voltage drop	T _j = 150 °C	IF = 100 A	-	0.63	0.68	V
v _F .	Polward voltage drop	T _j = 25 °C	I _F = 200 A	-	-	1.01	V
		T _j = 150 °C		-	0.78	0.86	

^{1.} Pulse test: t_p = 5 ms, δ < 2 %

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To evaluate the conduction losses use the following equation: P = 0.5 x $I_{F(AV)}$ + 0.0018 $I_{F}^{2}_{(RMS)}$

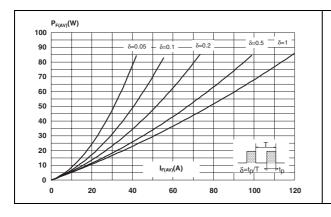
$$P = 0.5 \times I_{E(AV)} + 0.0018 I_{E}^{2}_{(BMS)}$$

^{2.} Pulse test: t_p = 380 μ s, δ < 2 %

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Figure 1. Conduction losses versus average Figur current (per diode)

Figure 2. Average forward current versus ambient temperature $(\delta = 0.5, per diode)$



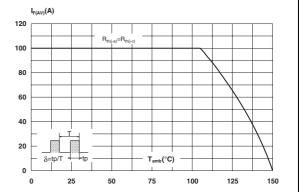
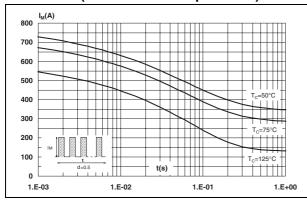


Figure 3. Non-repetitive surge peak forward current vesus overload duration (maximum values per diode)

Figure 4. Relative variation of thermal impedance (junction to case) versus pulse duration



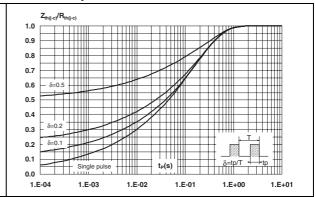
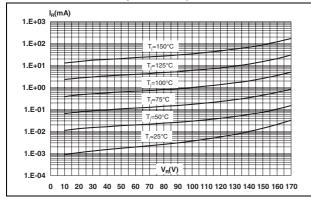
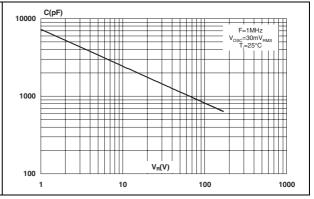


Figure 5. Reverse leakage current versus reverse voltage applied (typical values per diode)

Figure 6. Junction capacitances versus reverse voltage applied (typical values per diode)





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Figure 7. Forward voltage drop versus forward current (per diode, low level)

T_{j=150°C} (Maximum values)

T_{j=150°C} (Maximum values)

T_{j=25°C} (Maximum values)

T_{j=25°C} (Maximum values)

V_{FM}(V)

0.0 0.1 0.2 0.3 0.4 0.5 0.6 0.7 0.8 0.9 1.0

Figure 8. Forward voltage drop versus forward current (per diode, high level)

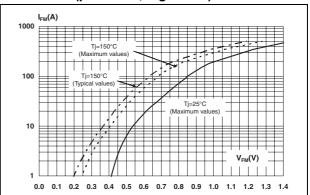
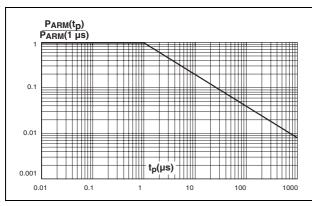
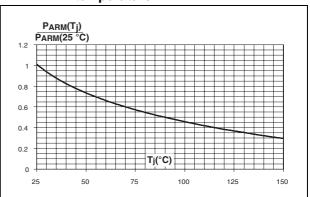


Figure 9. Normalized avalanche power derating versus pulse duration

Figure 10. Normalized avalanche power derating versus junction temperature





2 Package information

Epoxy meets UL94, V0

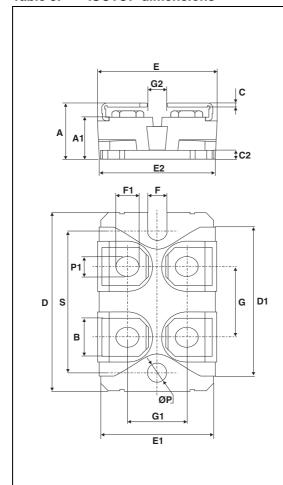
Cooling method: by conduction (C)Recommended torque value: 1.3 N·m

Maximum torque value: 1.5 N⋅m

STMicroelectronics strongly recommend the use of the screws delivered with this product. The use of anyother screws is entirely at the user's own risk and will invalidate the warranty.

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: www.st.com. ECOPACK[®] is an ST trademark.

Table 5. ISOTOP dimensions



	Dimensions				
Ref.	Millim	neters	Inc	hes	
	Min.	Max.	Min.	Max.	
Α	11.80	12.20	0.465	0.480	
A1	8.90	9.10	0.350	0.358	
В	7.8	8.20	0.307	0.323	
С	0.75	0.85	0.030	0.033	
C2	1.95	2.05	0.077	0.081	
D	37.80	38.20	1.488	1.504	
D1	31.50	31.70	1.240	1.248	
Е	25.15	25.50	0.990	1.004	
E1	23.85	24.15	0.939	0.951	
E2	24.80 typ.		0.976 typ.		
G	14.90	15.10	0.587	0.594	
G1	12.60	12.80	0.496	0.504	
G2	3.50	4.30	0.138	0.169	
F	4.10	4.30	0.161	0.169	
F1	4.60	5.00	0.181	0.197	
Р	4.00	4.30	0.157	0.69	
P1	4.00	4.40	0.157	0.173	
S	30.10	30.30	1.185	1.193	

3 Ordering information

Table 6. Ordering information

Order code	Marking	Package	Weight	Base qty ⁽¹⁾	Delivery mode
STPS200170TV1Y	STPS200170TV1Y	ISOTOP	27 g without screws	10 with screws	Tube

^{1.} This product is supplied with 40 terminal screws and washers for each tube. The screws and washers are supplied in a separate pack with the order.

4 Revision history

Table 7. Document revision history

Date	Revision	Changes	
02-Mar-2010	1	First issue.	
07-Oct-2011	2	Added torque values in Section 2.	

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